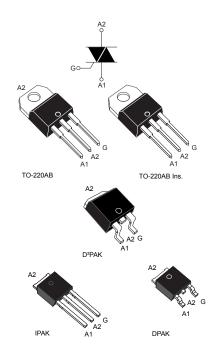


Snubberless™, logic level and standard 8 A Triacs



Features

- On-state rms current, I_{T(RMS)} 8 A
- Repetitive peak off-state voltage, V_{DRM} / V_{RRM} 600 V to 800 V
- Triggering gate current, I_{GT} 5 to 50 mA

Description

Available either in through-hole and surface-mount packages, these devices are suitable for general purpose AC switching. They can be used as an ON/OFF function in applications such as static relays, heating regulation, induction motor starting circuits or for phase control operation in light dimmers and motor speed controllers, etc.

The Snubberless versions (BTA, BTB08_xxxxW and T8 series) are specially recommended for use on inductive loads, thanks to their high commutation performance.

Logic level versions are designed to interface directly with low power drivers such as Microcontrollers.

By using an internal ceramic pad, the BTA series provide voltage insulated tab (rated at 2500 V_{RMS}) in compliance with UL standards (file ref.: E81734).

Product status link

BTA08,BTB08,T810,T835,T850



1 Characteristics

Table 1. Absolute maximum ratings ($T_j = 25$ °C unless otherwise stated)

| Symbol | Paran | neter | | Value | Unit |
|---------------------|---|----------------------------|--------------------------|-------|------------------|
| I | DMC on state ourself (full size uses) | IPAK, DPAK,TO-220AB, D2PAK | T _c = 110 °C | | _ |
| I _{T(RMS)} | RMS on-state current (full sine wave) | TO-220AB Ins. | T _c = 100 °C | 8 | Α |
| L | Non repetitive surge peak on-state current (full | f = 50 Hz | t = 20 ms | 80 | _ |
| ITSM | cycle, T _j initial = 25 °C) | f = 60 Hz | t _p = 16.7 ms | 84 | Α |
| I ² t | I ² t value for fusing | | t _p = 10 ms | 36 | A ² s |
| dl/dt | Critical rate of rise of on-state current $I_G = 2 x$ I_{GT} , tr $\leq 100 \text{ ns}$ | f = 120 Hz | T _j = 125 °C | 50 | A/µs |
| I _{GM} | Peak gate current | t _p = 20 μs | T _j = 125 °C | 4 | Α |
| P _{G(AV)} | Average gate power dissipation | 1 | W | | |
| T _{stg} | Storage junction temperature range | -40 to +150 | °C | | |
| Tj | Operating junction temperature range | -40 to +125 | °C | | |

Table 2. Electrical characteristics (T_j = 25 °C, unless otherwise specified) Snubberless and logic level (3 quadrants)

| Symbol | Parameter | Quadrant | | | T8 | | | BTA08 | /BTB0 | 8 | Unit |
|--------------------------------|--|--------------|------|-----|-----|------|-----|-------|-------|------|-------|
| Syllibol | Farameter | Quaurant | | 10 | 35 | 50 | TW | sw | cw | BW | Uiiii |
| I _{GT} ⁽¹⁾ | $V_D = 12 \text{ V, R}_1 = 30 \Omega$ | 1 - 11 - 111 | Max. | 10 | 35 | 50 | 5 | 10 | 35 | 50 | mA |
| V _{GT} | VD = 12 V, IV = 50 12 | 1 - 11 - 111 | Max. | 1.2 | | | | | V | | |
| V _{GD} | $V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega, T_j = 125 \text{ °C}$ | 1 - 11 - 111 | Min. | | | | 0.2 | | | | V |
| I _H (2) | I _T = 100 mA | 1 - 11 - 111 | Max. | 15 | 35 | 75 | 10 | 15 | 35 | 50 | mA |
| IL | I _G = 1.2 x I _{GT} | 1 - 111 | Max. | 25 | 50 | 70 | 10 | 25 | 50 | 70 | mA |
| 'L | 1.2 \ 1.6 | Ш | Max. | 30 | 60 | 110 | 15 | 30 | 60 | 80 | ША |
| dV/dt (2) | $V_D = 67\% V_{DRM}$, gate open, $T_j = 125 °C$ | | Max. | 40 | 400 | 1000 | 20 | 40 | 400 | 1000 | V/µs |
| | $(dV/dt)c = 0.1 V/\mu s$, $T_j = 125 °C$ | | Min. | 5.4 | | | 3.5 | 5.4 | | | |
| (dl/dt)c (2) | $(dV/dt)c = 10 V/\mu s, T_j = 125 °C$ | | Min. | 2.8 | | | 1.5 | 2.98 | | | A/ms |
| | Without snubber, T _j = 125 °C | | Min. | | 4.5 | 7 | | | 4.5 | 7 | |

^{1.} Minimum I_{GT} is guaranteed at 5 % of I_{GT} max.

DS2114 - Rev 13 page 2/20

^{2.} For both polarities of A2 referenced to A1



| Table 3. | Standard | (4 c | quadrants) |) |
|----------|----------|------|------------|---|
|----------|----------|------|------------|---|

| Symbol | Parameter | Quadrant | | BTA08 | Unit | |
|--------------------------------|---|--------------|------|-------|------|---------|
| Syllibol | Parameter | Quadrant | | С | В |) Ullit |
| I _{GT} ⁽¹⁾ | | 1 - 11 - 111 | May | 25 | 50 | m A |
| 'GT \'' | $V_D = 12 \text{ V}, R_L = 33 \Omega$ | IV | Max. | 50 | 100 | mA |
| V _{GT} | | All | Max. | 1 | .3 | V |
| V _{GD} | $V_D = V_{DRM}, R_L = 33 \Omega, T_j = 125 ^{\circ}C$ | All | Min. | 0.2 | | V |
| I _H ⁽²⁾ | I _T = 500 mA | 1 - 11 - 111 | Max. | 25 | 50 | mA |
| | 1 -421 | I - III - IV | | 40 | 50 | 4 |
| l _L | $I_G = 1.2 I_{GT}$ | II | Max. | 80 | 100 | mA |
| dV/dt (2) | V _D = 67 % V _{DRM} gate open, T _j = 125 °C | | Min. | 200 | 400 | V/µs |
| (dV/dt)c (2) | (dl/dt)c = 3.5 A/ms, T _j = 125 °C | | Min. | 5 | 10 | A/ms |

- 1. Minimum I_{GT} is guaranteed at 5 % of I_{GT} max.
- 2. For both polarities of A2 referenced to A1

Table 4. Static electrical characteristics

| Symbol | Test condition | Value | Unit | | |
|--------------------------------|---|-------------------------|------|------|----|
| V _{TM} ⁽¹⁾ | $I_{TM} = 11 \text{ A}, t_p = 380 \mu\text{s}$ | T _j = 25 °C | Max. | 1.55 | V |
| V _{TO} ⁽¹⁾ | threshold on-state voltage | T _j = 125 °C | Max. | 0.85 | V |
| R _D ⁽¹⁾ | Dynamic resistance | T _j = 125 °C | Max. | 50 | mΩ |
| l==l== | $V_{DRM} = V_{RRM}$ | T _j = 25 °C | Max. | 5 | μA |
| IDRM IRRM | | T _j = 125 °C | Max. | 1 | mA |

^{1.} For both polarities of A2 referenced to A1

Table 5. Thermal resistance

| Symbol | | Value | Unit | | |
|---------------|--|---------------------------|--------------------------------|-----|--------|
| Б | R _{th(j-c)} Max. junction to case thermal resistance (AC) | | IPAK / D2PAK / DPAK / TO-220AB | 1.6 | °C/W |
| ™th(j-c) | | | TO-220AB Insulated | 2.5 | C/VV |
| | | S = 2 cm ² (1) | D²PAK | 45 | |
| В | Junction to ambient (typ.) | S = 1 cm ²⁽¹⁾ | DPAK | 70 | °C 141 |
| $R_{th(j-a)}$ | lung tion to such it at the a | | TO-220AB / TO-220AB Insulated | 60 | °C/W |
| | Junction to ambient (typ.) | | IPAK | | |

1. S = Copper surface under tab.

DS2114 - Rev 13 page 3/20



1.1 Characteristics (curves)

Figure 1. Maximum power dissipation versus on-state RMS current (full cycle)

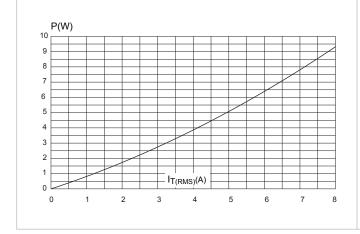


Figure 2. RMS on-state current versus temperature (full cycle)

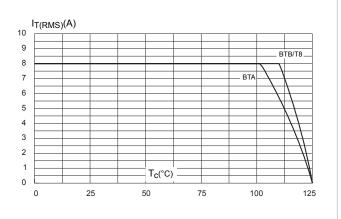


Figure 3. RMS on-state current versus ambient temperature (full cycle)

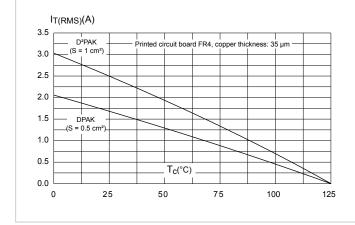


Figure 4. Relative variation of thermal impedance versus pulse duration

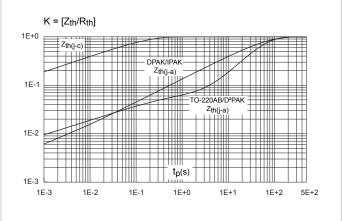


Figure 5. On-state characteristics (maximum values)

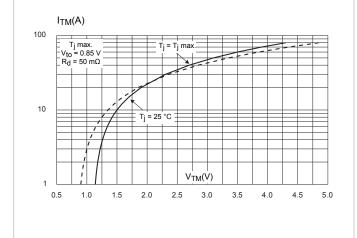
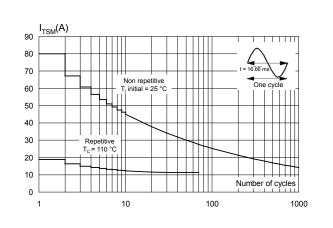


Figure 6. Surge peak on-state current versus number of cycles



DS2114 - Rev 13 page 4/20



Figure 7. Non repetitive surge peak on-state current for a sinusoidal pulse ($t_p < 10 \text{ ms}$)

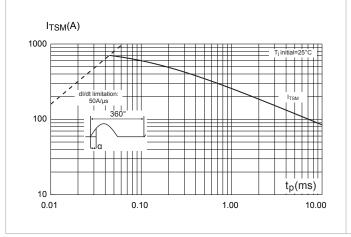


Figure 8. Relative variation of gate trigger current

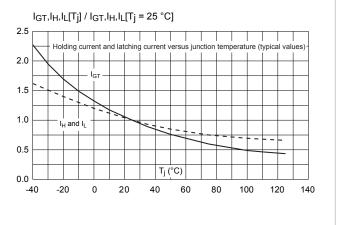


Figure 9. Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values)

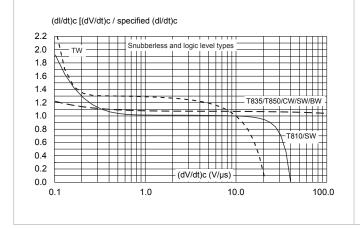


Figure 10. Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values)

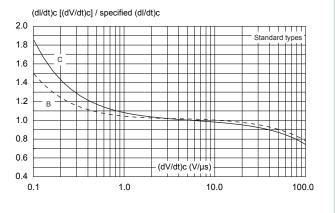


Figure 11. Relative variation of critical rate of decrease of main current versus junction temperature

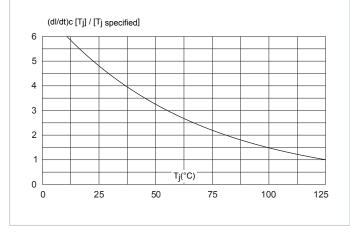
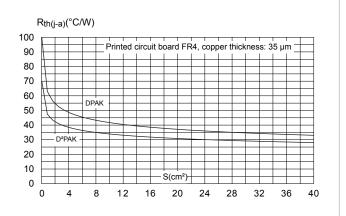


Figure 12. DPAK and D2PAK thermal resistance junction to ambient versus copper surface under tab



DS2114 - Rev 13 page 5/20



2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

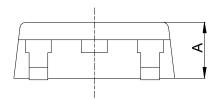
DS2114 - Rev 13 page 6/20

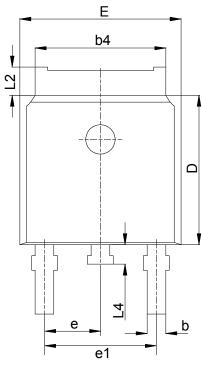


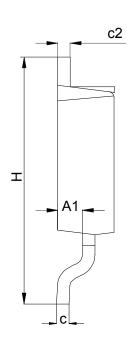
2.1 DPAK package information

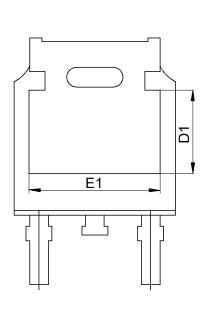
- Epoxy meets UL94, V0
- Lead-free package
- Recommended torque: 0.4 to 0.6 N·m

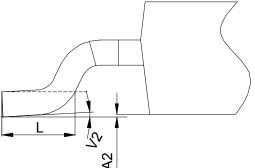
Figure 13. DPAK package outline











DS2114 - Rev 13 page 7/20

+8°



Dimensions Millimeters Ref. Inches⁽¹⁾ Min. Max. Min. Тур. Max. Тур. 2.18 0.0945 Α 2.40 0.0858 Α1 0.90 1.10 0.0354 0.0433 0.03 0.0012 0.0091 A2 0.23 0.64 0.90 0.0252 0.354 b b4 4.95 5.46 0.1949 0.2150 С 0.46 0.61 0.0181 0.0240 c2 0.46 0.60 0.0181 0.0236 D 5.97 6.22 0.2350 0.2449 5.10 0.2008 D1 Ε 6.35 6.73 0.2500 0.2650 E1 4.32 0.1701 е 2.29 0.0900 4.57 0.1800 e1 Н 9.35 10.40 0.3681 0.4094 0.0701 L 1.00 1.78 0.0394 L2 1.27 0.0500 L4 0.60 1.02 0.0236 0.0402

Table 6. DPAK package mechanical data

0°

V2

Note:

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

+8°

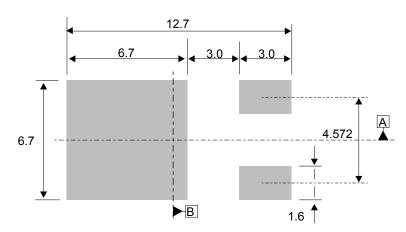


Figure 14. DPAK recommended footprint (dimensions are in mm)

0°

The device must be positioned within $\bigcirc 0.05 \text{ AB}$

DS2114 - Rev 13 page 8/20

^{1.} Dimensions in inches are given for reference only



2.2 IPAK package information

Figure 15. IPAK package outline

Note: This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

DS2114 - Rev 13 page 9/20



Table 7. IPAK package mechanical data

| | | | | Dimensions | | |
|------|------|-------------|------|------------|-----------------------|--------|
| Ref. | | Millimeters | | | Inches ⁽¹⁾ | |
| | Min. | Тур. | Max. | Min. | Тур. | Max. |
| Α | 2.20 | | 2.40 | 0.0866 | | 0.0945 |
| A1 | 0.90 | | 1.10 | 0.0354 | | 0.0433 |
| b | 0.64 | | 0.90 | 0.0252 | | 0.0354 |
| b2 | | | 0.95 | | | 0.0374 |
| b4 | 5.20 | | 5.43 | 0.2047 | | 0.2138 |
| B5 | | 0.30 | | | 0.0118 | |
| С | 0.45 | | 0.60 | 0.0177 | | 0.0236 |
| c2 | 0.46 | | 0.60 | 0.0181 | | 0.0236 |
| D | 6.00 | | 6.20 | 0.2362 | | 0.2441 |
| E | 6.40 | | 6.65 | 0.2520 | | 0.2618 |
| е | | 2.28 | | | 0.0898 | |
| e1 | 4.40 | | 4.60 | 0.1732 | | 0.1811 |
| Н | | 16.10 | | | 0.6339 | |
| L | 9.00 | | 9.60 | 0.3545 | | 0.3780 |
| L1 | 0.80 | | 1.20 | 0.0315 | | 0.0472 |
| L2 | | 0.80 | 1.25 | | 0.0315 | 0.0492 |
| V1 | | 10° | | | 10° | |

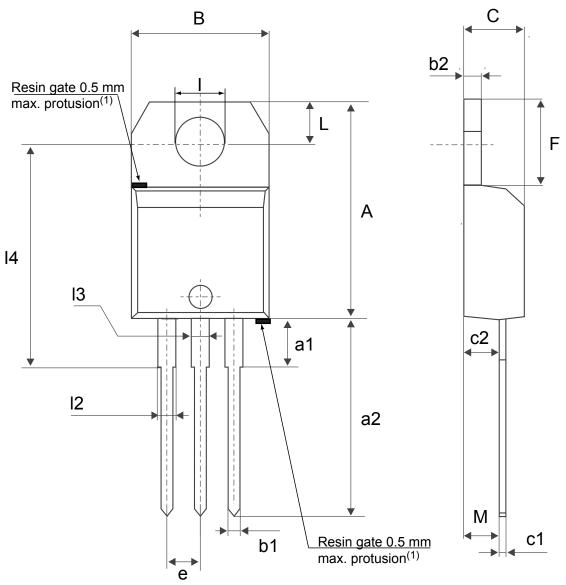
^{1.} Inch dimensions are for reference only.

DS2114 - Rev 13 page 10/20



2.3 TO-220AB Insulated package information

Figure 16. TO-220AB Insulated package outline



(1)Resin gate position accepted in one of the two positions or in the symmetrical opposites.

DS2114 - Rev 13 page 11/20



Figure 17. TO-220AB Insulated package outline

Table 8. TO-220AB Insulated package mechanical data

| | | | Di | mensions | | | |
|------|-------|-------------|-------|----------|--------|--------|--|
| Ref. | | Millimeters | | | Inches | | |
| | Min. | Тур. | Max. | Min. | Тур. | Max. | |
| Α | 15.20 | | 15.90 | 0.5984 | | 0.6260 | |
| a1 | | 3.75 | | | 0.1476 | | |
| a2 | 13.00 | | 14.00 | 0.5118 | | 0.5512 | |
| В | 10.00 | | 10.40 | 0.3937 | | 0.4094 | |
| b1 | 0.61 | | 0.88 | 0.0240 | | 0.0346 | |
| b2 | 1.23 | | 1.32 | 0.0484 | | 0.0520 | |
| С | 4.40 | | 4.60 | 0.1732 | | 0.1811 | |
| c1 | 0.49 | | 0.70 | 0.0193 | | 0.0276 | |
| c2 | 2.40 | | 2.72 | 0.0945 | | 0.1071 | |
| е | 2.40 | | 2.70 | 0.0945 | | 0.1063 | |
| F | 6.20 | | 6.60 | 0.2441 | | 0.2598 | |
| 1 | 3.73 | | 3.88 | 0.1469 | | 0.1528 | |
| L | 2.65 | | 2.95 | 0.1043 | | 0.1161 | |
| 12 | 1.14 | | 1.70 | 0.0449 | | 0.0669 | |
| 13 | 1.14 | | 1.70 | 0.0449 | | 0.0669 | |
| 14 | 15.80 | 16.40 | 16.80 | 0.6220 | 0.6457 | 0.6614 | |
| М | | 2.6 | | | 0.1024 | | |

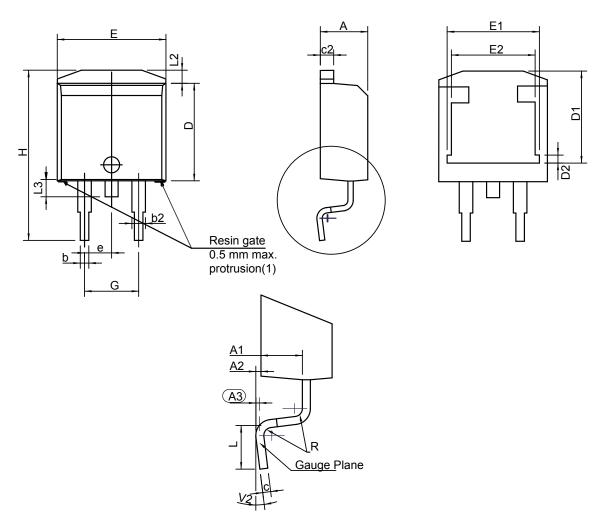
^{1.} Inch dimensions are for reference only.

DS2114 - Rev 13 page 12/20



2.4 D²PAK package information

Figure 18. D²PAK package outline



(1) Resin gate position accepted in one of the two positions or in the symmetrical opposites

DS2114 - Rev 13 page 13/20



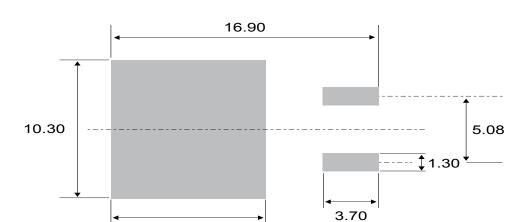
Table 9. D²PAK package mechanical data

| | | | | Dimensions | | |
|------|-------|-------------|-------|------------|--------|--------|
| Ref. | | Millimeters | | | Inches | |
| | Min. | Тур. | Max. | Min. | Тур. | Max. |
| Α | 4.30 | | 4.60 | 0.1693 | | 0.1811 |
| A1 | 2.49 | | 2.69 | 0.0980 | | 0.1059 |
| A2 | 0.03 | | 0.23 | 0.0012 | | 0.0091 |
| A3 | | 0.25 | | | 0.0098 | |
| b | 0.70 | | 0.93 | 0.0276 | | 0.0366 |
| b2 | 1.25 | | 1.7 | 0.0492 | | 0.0669 |
| С | 0.45 | | 0.60 | 0.0177 | | 0.0236 |
| c2 | 1.21 | | 1.36 | 0.0476 | | 0.0535 |
| D | 8.95 | | 9.35 | 0.3524 | | 0.3681 |
| D1 | 7.50 | | 8.00 | 0.2953 | | 0.3150 |
| D2 | 1.30 | | 1.70 | 0.0512 | | 0.0669 |
| е | 2.54 | | | 0.1 | | |
| E | 10.00 | | 10.28 | 0.3937 | | 0.4047 |
| E1 | 8.30 | | 8.70 | 0.3268 | | 0.3425 |
| E2 | 6.85 | | 7.25 | 0.2697 | | 0.2854 |
| G | 4.88 | | 5.28 | 0.1921 | | 0.2079 |
| Н | 15 | | 15.85 | 0.5906 | | 0.6240 |
| L | 1.78 | | 2.28 | 0.0701 | | 0.0898 |
| L2 | 1.27 | | 1.40 | 0.0500 | | 0.0551 |
| L3 | 1.40 | | 1.75 | 0.0551 | | 0.0689 |
| R | | 0.40 | | | 0.0157 | |
| V2 | 0° | | 8° | 0° | | 8° |

^{1.} Dimensions in inches are given for reference only

DS2114 - Rev 13 page 14/20





8.90

Figure 19. D²PAK recommended footprint (dimensions are in mm)

DS2114 - Rev 13 page 15/20



3 Ordering information

Figure 20. Ordering information scheme (BTA08 and BTB08 series)

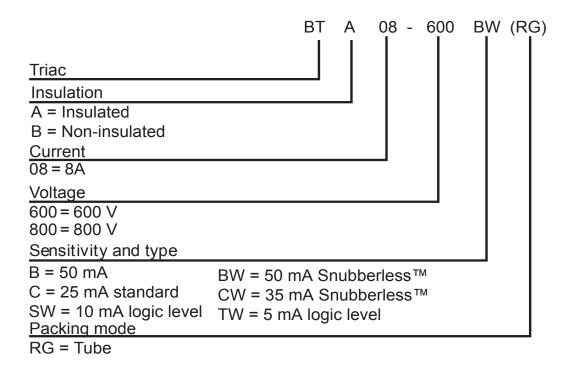
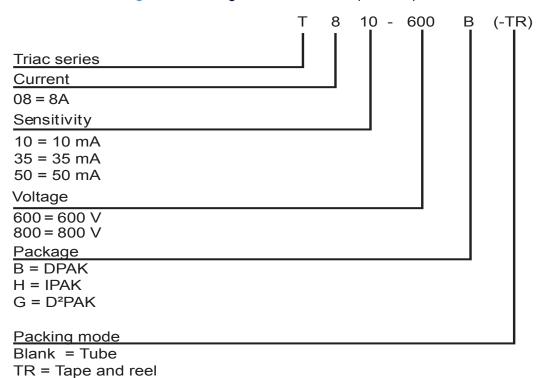


Figure 21. Ordering information scheme (T8 series)



DS2114 - Rev 13 page 16/20



Table 10. Product selector

| Part Number | Volta | ige (xxx) | Considiuidu | Tuna | Dackers |
|-------------|-------|-----------|---------------|--------------|--------------------|
| Part Number | 600 | 800 | - Sensitivity | Туре | Package |
| T810-xxxB | Х | Х | 10 mA | Logic Level | DPAK |
| T835-xxxH | Х | | 35 mA | Snubberless™ | IPAK |
| T810-xxxG | Х | | 10 mA | Logic Level | D ² PAK |
| T835-xxxG | Х | X | 35 mA | Snubberless™ | D ² PAK |
| T850-xxxG | Х | X | 50 mA | Snubberless™ | D ² PAK |
| BTA08-xxxS | Х | | 10 mA | Logic Level | TO-220AB Ins. |
| BTA08-xxxC | Х | Х | 35 mA | Standard | TO-220AB Ins. |
| BTA08-xxxB | Х | | 50 mA | Standard | TO-220AB Ins. |
| BTA08-xxxTW | Х | | 5 mA | Logic Level | TO-220AB Ins. |
| BTA08-xxxSW | Х | | 10 mA | Logic Level | TO-220AB Ins. |
| BTA08-xxxCW | Х | | 35 mA | Snubberless™ | TO-220AB Ins. |
| BTA08-xxxBW | Х | Х | 50 mA | Snubberless™ | TO-220AB Ins. |
| BTB08-xxxS | Х | | 10 mA | Logic Level | TO-220AB |
| BTB08-xxxC | Х | | 35 mA | Standard | TO-220AB |
| BTB08-xxxB | Х | | 50 mA | Standard | TO-220AB |
| BTB08-xxxTW | Х | Х | 5 mA | Logic Level | TO-220AB |
| BTB08-xxxSW | Х | | 10 mA | Logic Level | TO-220AB |
| BTB08-xxxCW | Х | Х | 35 mA | Snubberless™ | TO-220AB |
| BTB08-xxxBW | Х | | 50 mA | Snubberless™ | TO-220AB |

DS2114 - Rev 13 page 17/20



Table 11. Ordering information

| Order code | Marking | Package | Weight | Base qty. | Delivery mode |
|---------------|-------------|--------------------|--------|-----------|---------------|
| T810-600B | T8 1060 | | | | |
| T835-600B | T8 3560 | - | | 75 | Tube |
| T835-800B | T8 3580 | | | | |
| T810-600B-TR | T8 1060 | DPAK | 0.30 | | |
| T810-800B-TR | T8 1080 | - | | 2500 | Tape&Reel 13" |
| T835-600B-TR | T8 3560 | | | 2500 | тарежкеет то |
| T835-800B-TR | T8 3580 | | | | |
| T835-600H | T8 3560 | IPAK | 0.40 | 75 | Tube |
| T835-600G | T835-600G | | | | |
| T835-8G | T835-8G | | | 50 | Tube |
| T850-6G | T850-6G | | | 50 | Tube |
| T850-8G | T850-8G | | | | |
| T810-600G-TR | T810-600G | D ² PAK | 1.50 | | |
| T835-600G-TR | T835-600G | - | | | |
| T835-8G-TR | T835-8G | | | 1000 | Tape&Reel 13" |
| T850-6G-TR | T850-6G | | | | |
| T850-8G-TR | T850-8G | - | | | |
| BTA08-600SRG | BTA08-600S | | | | |
| BTA08-600BRG | BTA08-600B | - | | | |
| BTA08-600CRG | BTA08-600C | - | | | |
| BTA08-800CRG | BTA08-800C | | | | |
| BTA08-600BWRG | BTA08-600BW | TO-220AB Ins. | | | |
| BTA08-600CWRG | BTA08-600CW | - | | | |
| BTA08-600SWRG | BTA08-600SW | - | | | |
| BTA08-600TWRG | BTA08-600TW | - | | | |
| BTA08-800BWRG | BTA08-800BW | - | 0.00 | 50 | Tuba |
| BTB08-600BRG | BTB08-600B | | 2.30 | 50 | Tube |
| BTB08-600CRG | BTB08-600C | - | | | |
| BTB08-600SRG | BTB08-600S | - | | | |
| BTB08-600BWRG | BTB08-600BW | TO-220AB | | | |
| BTB08-600CWRG | BTB08-600CW | | | | |
| BTB08-600SWRG | BTB08-600SW | - | | | |
| BTB08-600TWRG | BTB08-600TW | - | | | |
| BTB08-800CWRG | BTB08-800CW | - | | | |
| BTB08-800TWRG | BTB08-800TW | - | | | |

DS2114 - Rev 13 page 18/20



Table 12. Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| Apr-2002 | 5A | Last update. |
| 13-Feb-2006 | 6 | TO-220AB delivery mode changed from bulk to tube. ECOPACK statement added. |
| 10-Mar-2010 | 7 | Updated ECOPACK statement and Figure 26 |
| 02-Jun-2014 | 8 | Updated DPAK and IPAK package information and reformatted to current standard. |
| 07-Nov-2016 | 9 | Updated Table 1 and reformatted to current standard. |
| 06-Jan-2017 | 10 | Updated Figure 20: "Ordering information scheme (T8 series)", Table 10: "Product selector" and Table 11: "Ordering information". |
| 09-Feb-2017 | 11 | Added T850 package information. |
| 24-Apr-2017 | 12 | Updated Figure 6 |
| | | Minor text changes to improve readability. |
| 14-Mar-2018 | 13 | Updated Table 2. Electrical characteristics ($T_j = 25$ °C, unless otherwise specified) Snubberless and logic level (3 quadrants), cover image, Figure 9. Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values) and Figure 21. Ordering information scheme (T8 series). |

DS2114 - Rev 13 page 19/20



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DS2114 - Rev 13 page 20/20